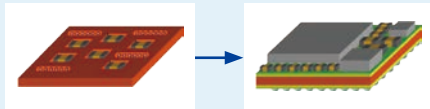


Topics

June 18, 2015

Made New Proposal of EOMIN™ for Double-Lens Cameras

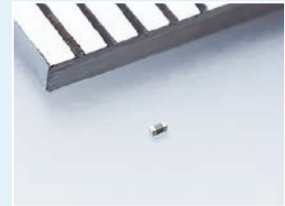
Developed for double-lens camera modules to be incorporated into thin mobile devices such as smartphones and tablets, the new proposal of EOMIN™, an embedded-parts multilayer wiring substrate, enables camera modules to be smaller by embedding parts.



June 24, 2015

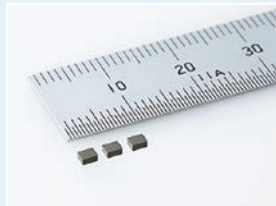
Commercialized World's First 0.022 μ F with 008004 size MLCC

Realizing the world's first 008004 size (0.25mm x 0.125mm) capacitor to achieve a capacitance of 0.022 μ F, this product contributes to making electronics such as smartphones and wearable devices smaller and thinner.



September 30, 2015

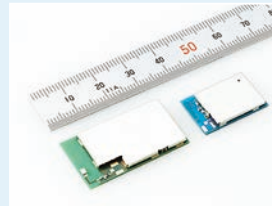
Added ME Series to Lineup of MCOIL™ Metal Power Inductors



The addition of the ME series expanded the lineup of the MCOIL™ series to five, allowing for a wide range of requirements, including needs for small, thin, high-performance devices, lowering costs, and for large-size devices and high-current-rate handling.

October 27, 2015

Launched Wireless Communication Module with Original Embedded Software



Embedded with original software, the module allows wireless communication with simple commands entered from outside. This product enables customers to significantly reduce development times.

February 3, 2016

Completed No. 2 Plant at Niigata Subsidiary Started Operations in March

Subsidiary NIIGATA TAIYO YUDEN CO., LTD. added production capacity for small, multilayer ceramic capacitors with high capacitance. In addition to consumer product market, the TAIYO YUDEN Group is building a system that can meet customer needs in markets such as automotive, industrial equipment, medical and healthcare, and environment and energy.



February 16, 2016

Achieved World's Thinnest 0603-size MLCC at 0.11mm

The world's thinnest 0603-size (0.6mm x 0.3mm) multilayer ceramic capacitor (MLCC) with a thickness of just 0.11mm, this product meets the need for parts suitable for higher-density mounting as devices become thinner with greater functionality, and battery sizes grow larger. The product will contribute to making already small and thin devices even thinner.



Active Participation in Focus Market Exhibitions

We are actively participating in exhibitions, such as CEATEC Japan, the largest comprehensive exhibition in Asia for cutting-edge IT and electronics, and Automotive Engineering Exposition, which feature our focus markets of automotive, industrial equipment, medical and healthcare, and environment and energy. We are also participating in overseas events such as electronica China to expand sales of our products and technologies.

